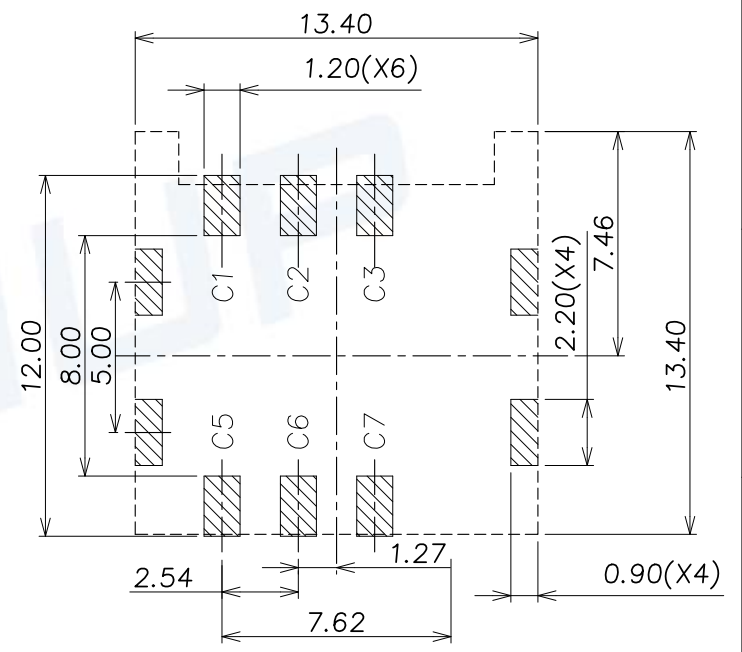
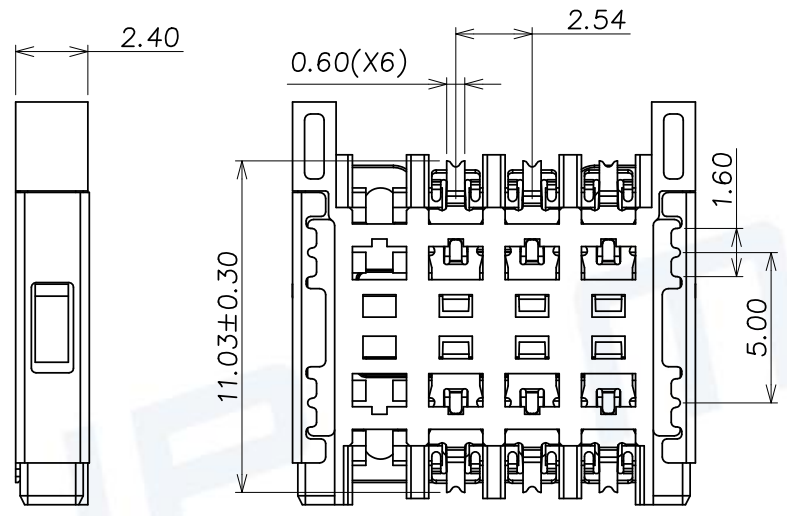
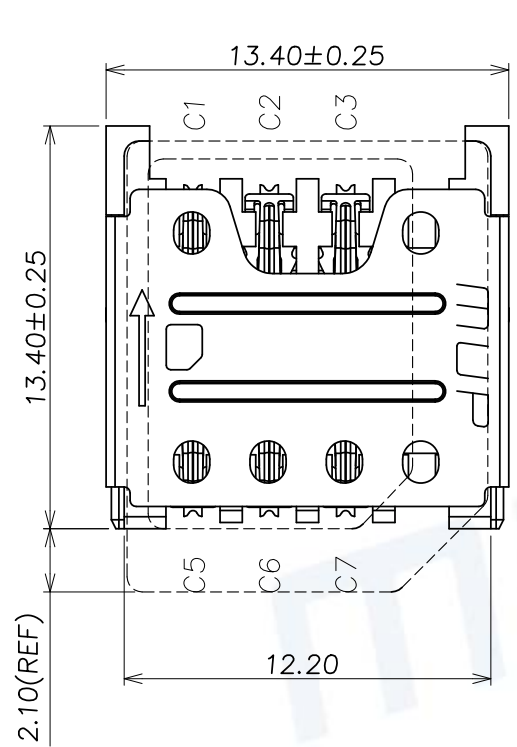
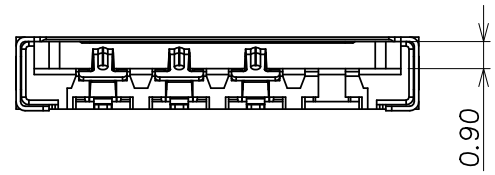


REV	DESCRIPTION OF REVISIONS	APPR	CHKD.	DRAW.	DATE
1	NEW			HUABO	2021/5/13
2	Original Model: C790-25			HUABO	2023/10/25



RECOMMENDED P.C.B LAYOUT
COMPONENT SIDE(TOLERANCE ±0.05)



TECHNICAL CHARACTERISTICS

- General Characteristics
Durability: 5,000 cycles min.
- Electrical Characteristics
Contact resistance: Initial: 50mΩ Max.
After Test: 100mΩ Max.
Insulation resistance: >1000MΩ/500V DC
- Solderability
IR reflow: 250°C, 5sec. Max
Manual soldering: 370°C, 3sec. Max
- Environmental Characteristics
Operating temperature: -40°C~+85°C
Operating humidity: 10%~+95%RH

ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	BASE	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area: Gold plated
3	SHELL	1	Stainless steel	SMT area: Gold plated

Unless otherwise specified, other tolerance are:

X	±0.35	X°	±5°
X.X	±0.25	X.X°	±4°
X.XX	±0.15	X.XX°	±3°
X.XXX	±0.10	X.XXX°	±2°

MUP MUP INDUSTRIAL CO.,LTD.

NAME: **Micro-SIM Card Connector**
MODEL NO: **MUP-C7090-25**
TYPE: **H2.40 Without post 6p**

PROJ.	UNIT	SCALE	DRAWN	HUABO	May.13.2021	DWG NO.:	DWG-C7090- 25-01
	MM	1:1	CHECKED	Sean	May.13.2021	SHEET	1/1
CUSTOMER DRAWING			APPROVAL	Simon	May.13.2021	REVISION	2

